

Jiaqi Bao

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MATLAB & Python

Laboratory of Pattern Recognition and Machine Learning (PRML)
Graduate School of Information Science and Technology, Hokkaido University

Research Interests

• Semi-Supervised Learning, Robustness, Domain Adaptation, Multi-Label Learning, Partial Multi-Label Learning.

Education

Hokkaido University

Hokkaido, Japan

Ph.D. in Information Science and Technology (Supervisor: Prof. Mineichi Kudo)

Apr. 2021 – Present

• (Thesis title) On Robustness of Linear Generalized Regression Algorithms for Classification.

Shenzhen University

Shenzhen, China

M.Sc. in Software Engineering (Supervisor: Prof. Zhihui Lai)

Sept. 2017 - Jun. 2020

• (Thesis title) Image Feature Extraction based on Robust Subspace Learning.

Submitted Manuscripts

- Bao, J., Kudo, M., et al. Robust Embedding Regression for Semi-Supervised Learning, *Pattern Recognition*. (Accepted)
- Bao, J., Kudo, M., et al. Redirected Transfer Learning for Robust Multi-Layer Subspace Learning, *Pattern Analysis and Application*. (Major Revision)

Publications & Patent

Journals

- Bao, J., Lai, Z. & Li, X. Relaxed local preserving regression for image feature extraction. Multimed Tools Appl. 80, 3729–3748 (2021).
- Lai, Z., <u>Bao, J.,</u> Kong, H. et al. Discriminative low-rank projection for robust subspace learning. *Int. J. Mach. Learn.* & Cyber. 11, 2247–2260 (2020). (Lai, Z. and Bao, J. contributed equally to this work)

Conferences

- Bao, J., Lu, J., Lai, Z., Liu, N., Lu, Y. (2019). Robust Embedding Regression for Face Recognition. In: Pattern Recognition and Computer Vision. PRCV 2019.
- Kimura, K., <u>Bao, J., Kudo, M., Sun, L.</u> (2022). Retargeted Regression Methods for Multi-label Learning. In: Structural, Syntactic, and Statistical Pattern Recognition. S+SSPR 2022.

Chinese Patent

。用于图像特征提取的松弛局部保持性回归方法. Patent No. <u>201910513242</u>, 2019.

Professional Services

• Reviewer: ICPR 2022

Personal Award

- Hokkaido University Ambitious Doctoral Fellowship. Apr. 2021 Present
- Chinese Government Scholarship (CSC). Apr. 2021
- Best Poster Award of The Artificial intelligence on fashion and textile Conference. Jul. 2018, Hong Kong
- Shenzhen University Academic Scholarship, First Prize. 2017&2018&2019